



US00D376794S

United States Patent [19]

Lim

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[45] Date of Patent: ****Dec. 24, 1996**

[54] **FACSIMILE**

5,183,431 2/1993 Todokoro D14/118 X

[75] Inventor: **Bong W. Lim**, Kyungki-do, Rep. of Korea

OTHER PUBLICATIONS

Panafax, Jun. 1994.

Radioshack, Aug. 1990, p. 4.

[73] Assignee: **Samsung Electronics Co., Ltd.**, Suwon, Rep. of Korea

Primary Examiner—Prabhakar G. Deshmukh

Attorney, Agent, or Firm—Flynn, Thiel, Boutell & Tanis, P.C.

[**] Term: **14 Years**

[21] Appl. No.: **49,637**

[57] CLAIM

[22] Filed: **Jan. 16, 1996**

The ornamental design for a facsimile, as shown and described.

[30] Foreign Application Priority Data

DESCRIPTION

Jul. 25, 1995 [KR] Rep. of Korea 1995-14068

[52] U.S. Cl. **D14/118**

[58] Field of Search D14/118, 124, D14/299; 358/400, 401; D18/36, 37

FIG. 1 is a perspective view of a facsimile showing my new design;

FIG. 2 is a perspective view thereof; with the cover shown in open position;

FIG. 3 is a top plan view thereof;

FIG. 4 is a bottom plan view thereof;

FIG. 5 is a front elevational view thereof;

FIG. 6 is a rear elevational view thereof;

FIG. 7 is a left-side elevational view thereof; and,

FIG. 8 is a right-side elevational view thereof.

[56] References Cited

U.S. PATENT DOCUMENTS

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D. 332,259	1/1993	Kashiwabara et al.	D14/118
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1 Claim, 3 Drawing Sheets

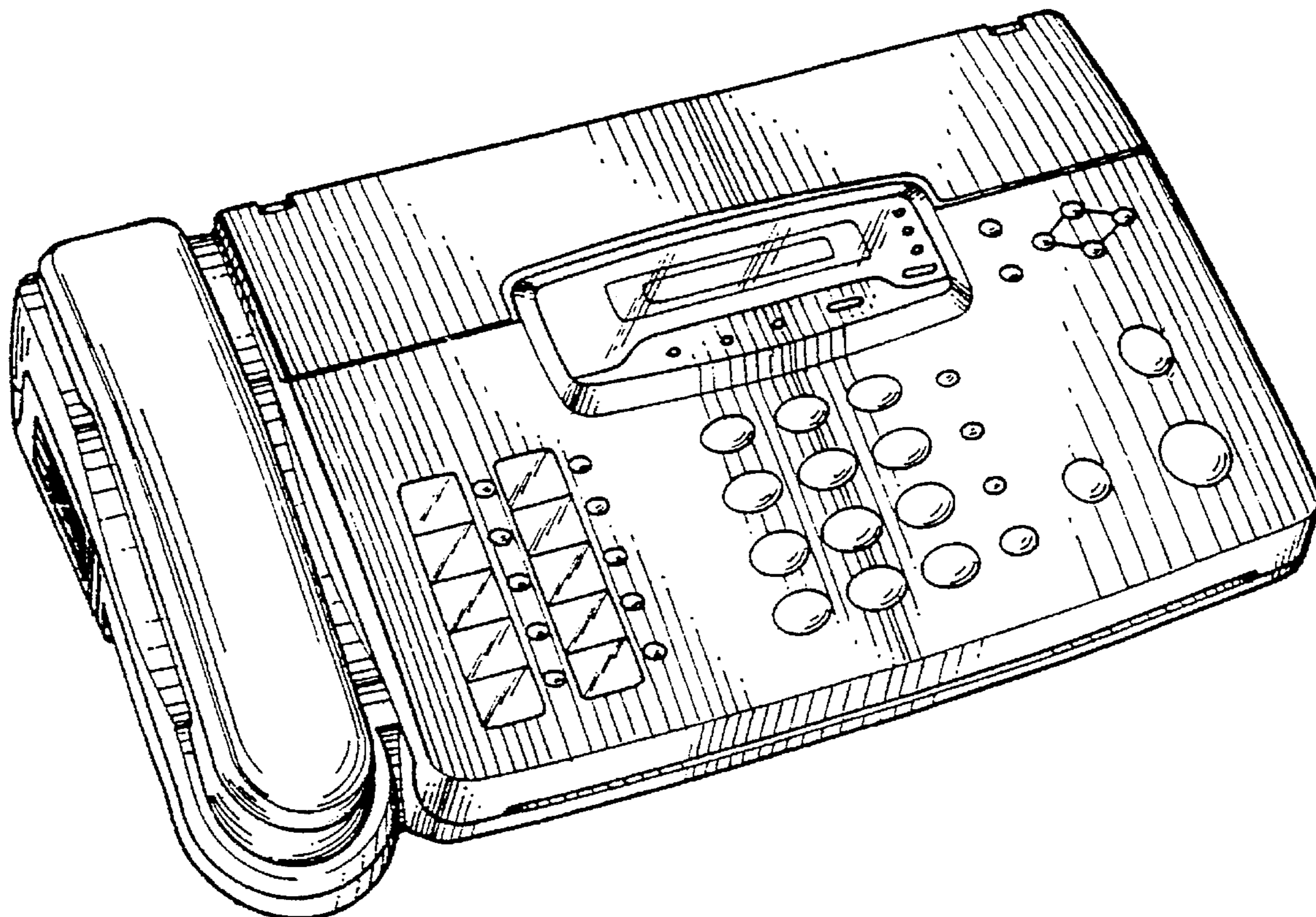


FIG. 1

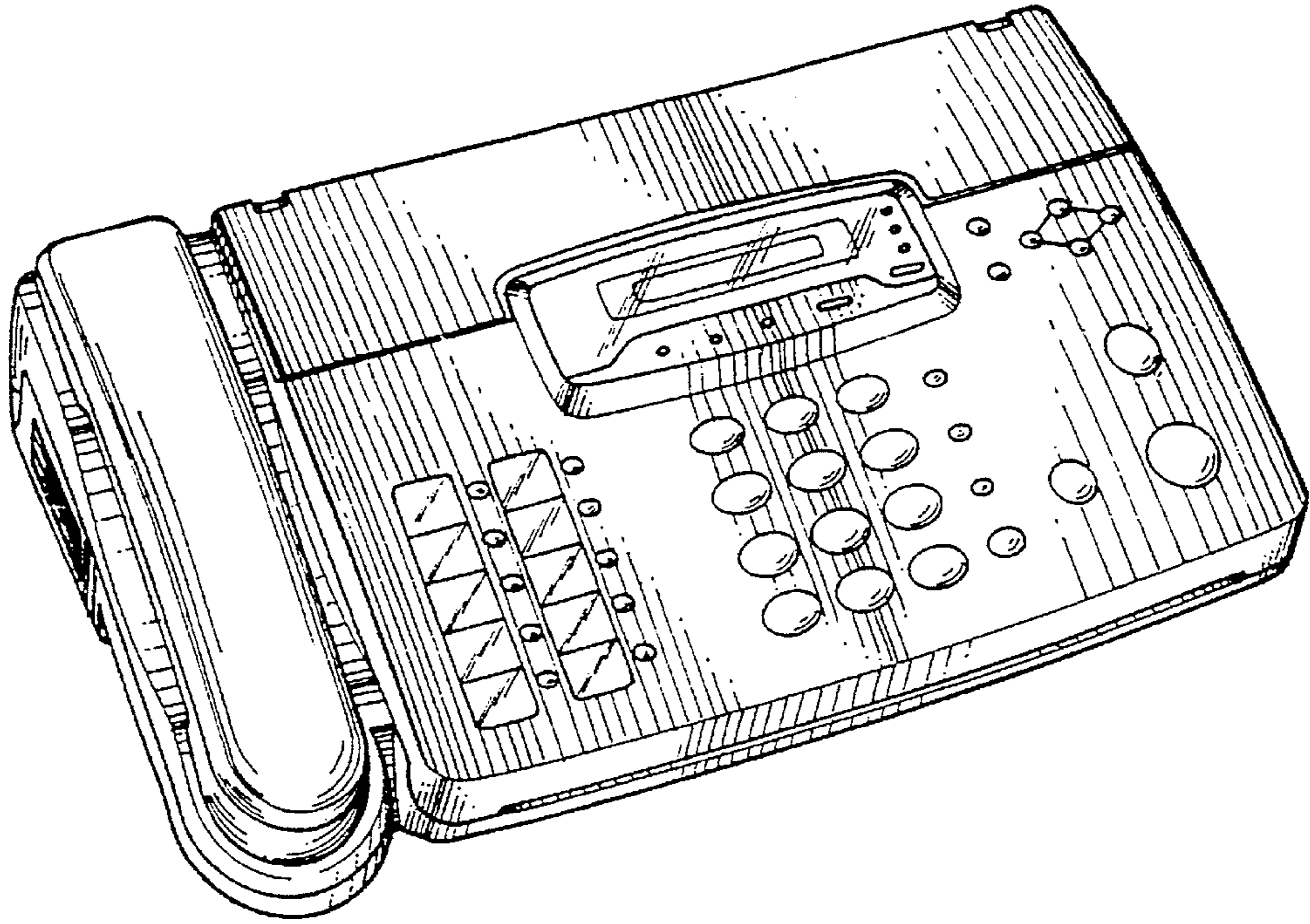


FIG. 2

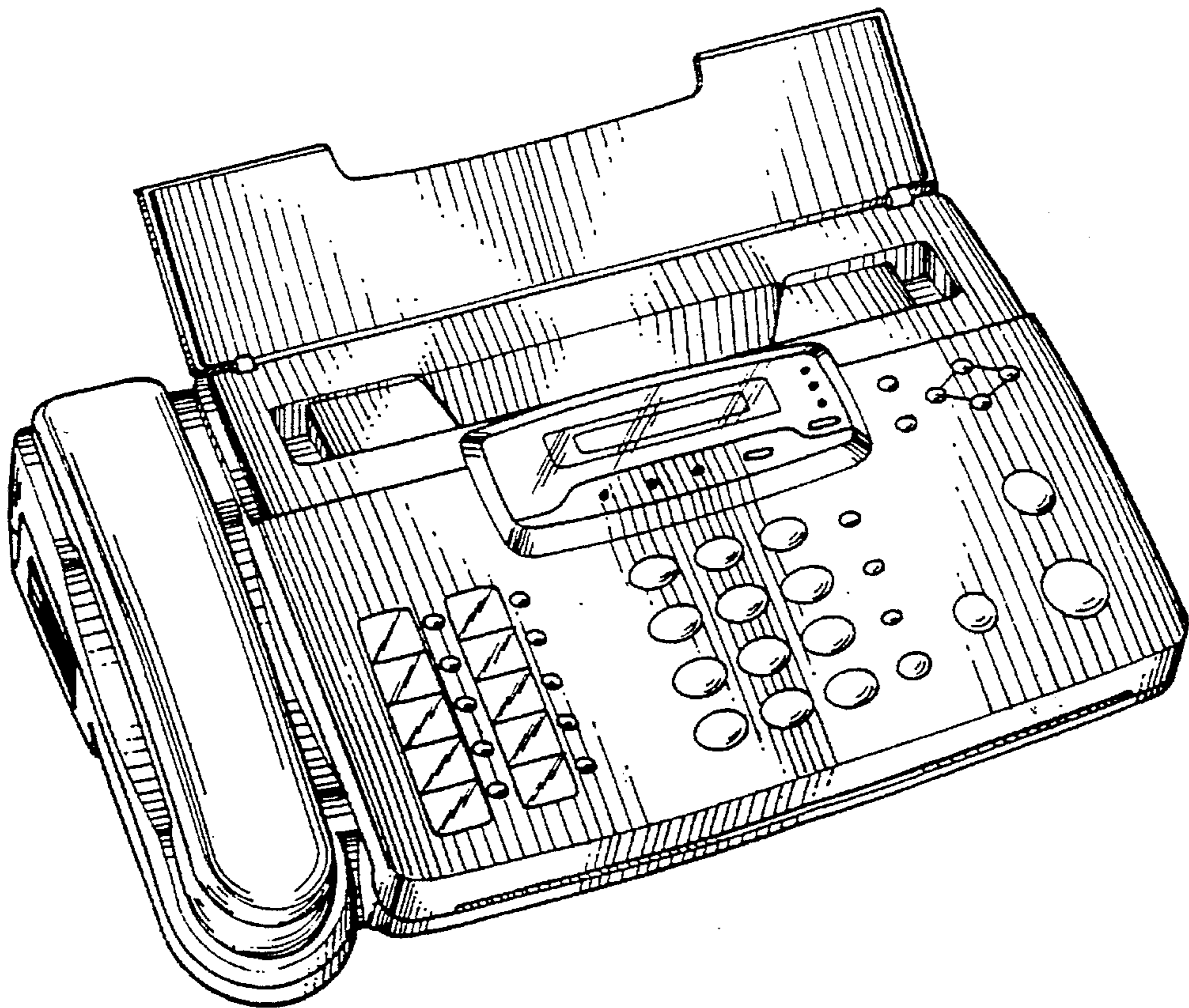


FIG. 3

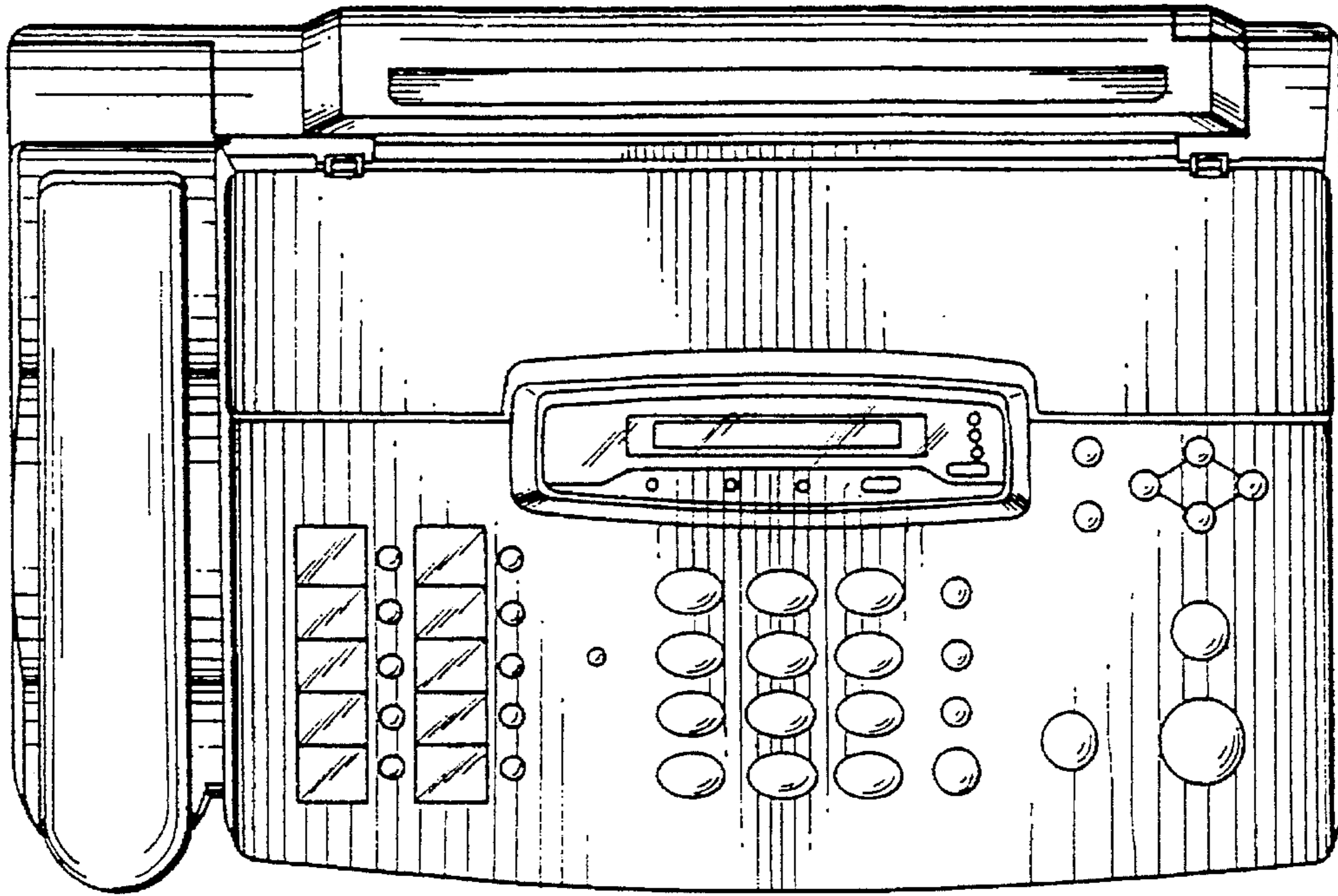
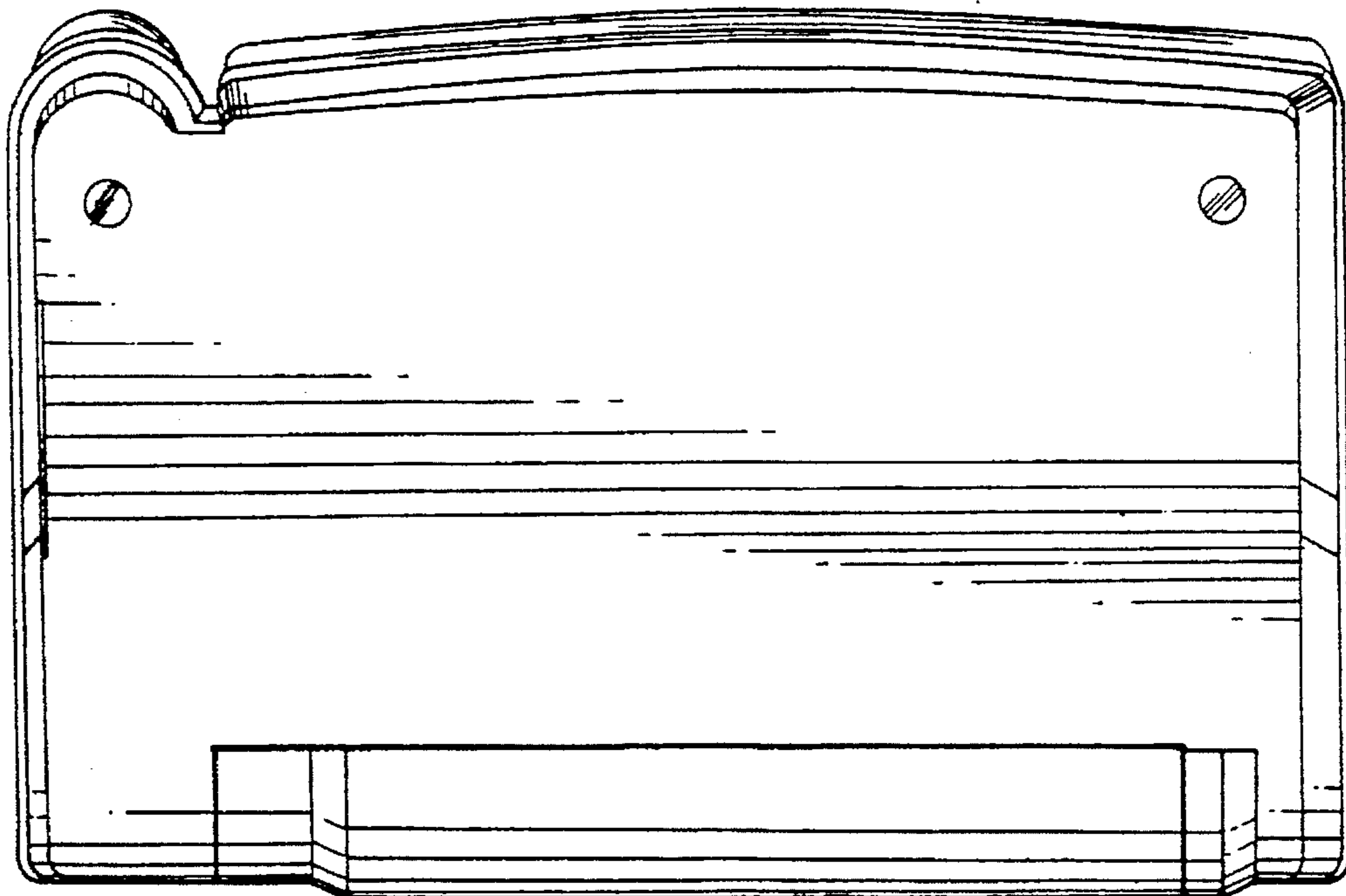
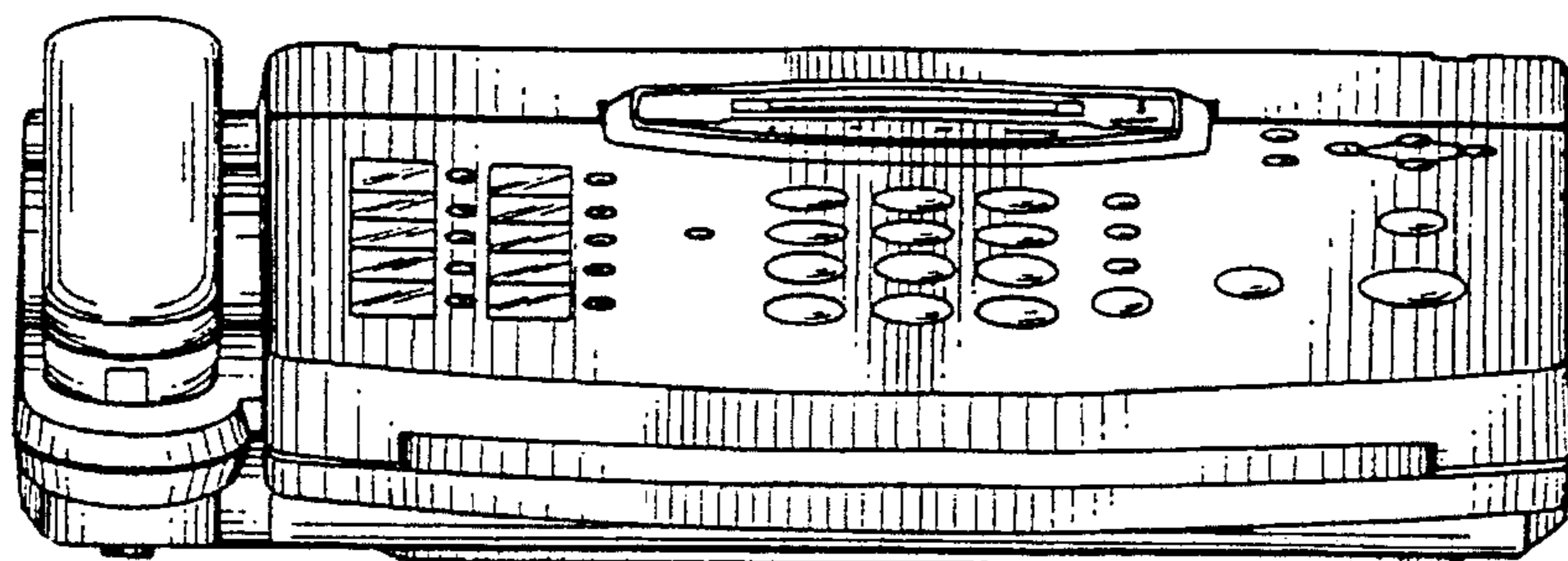


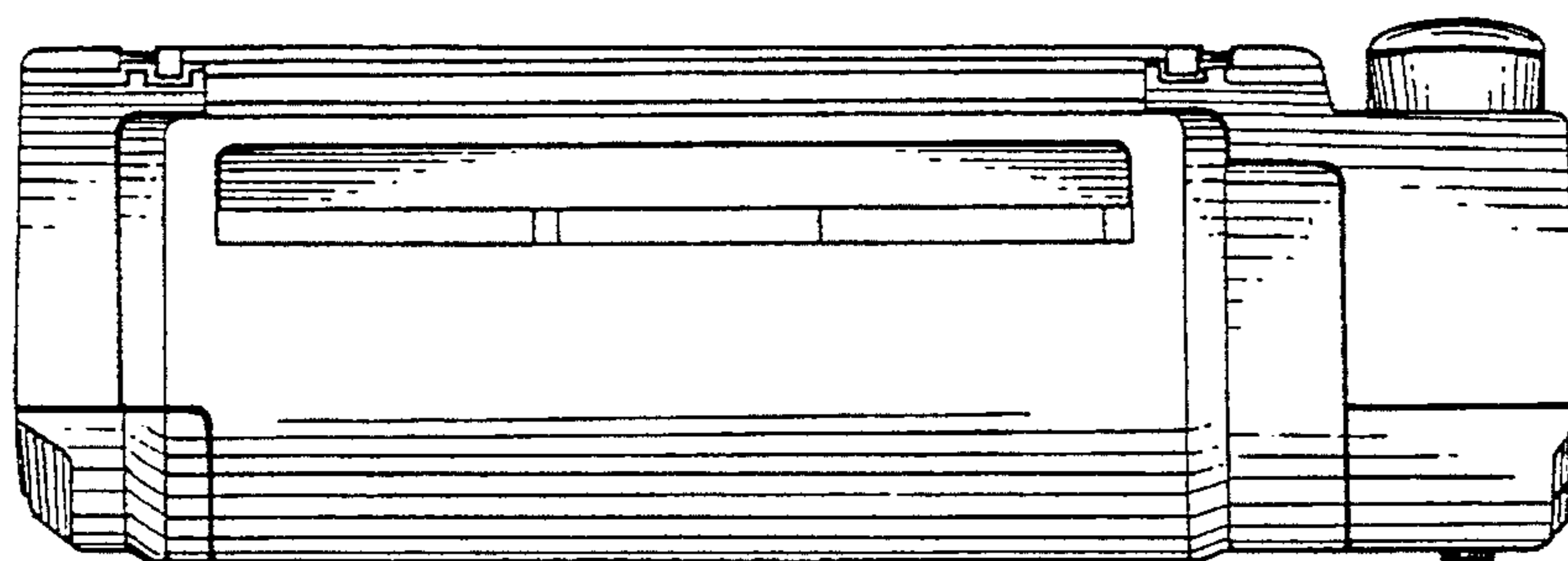
FIG. 4



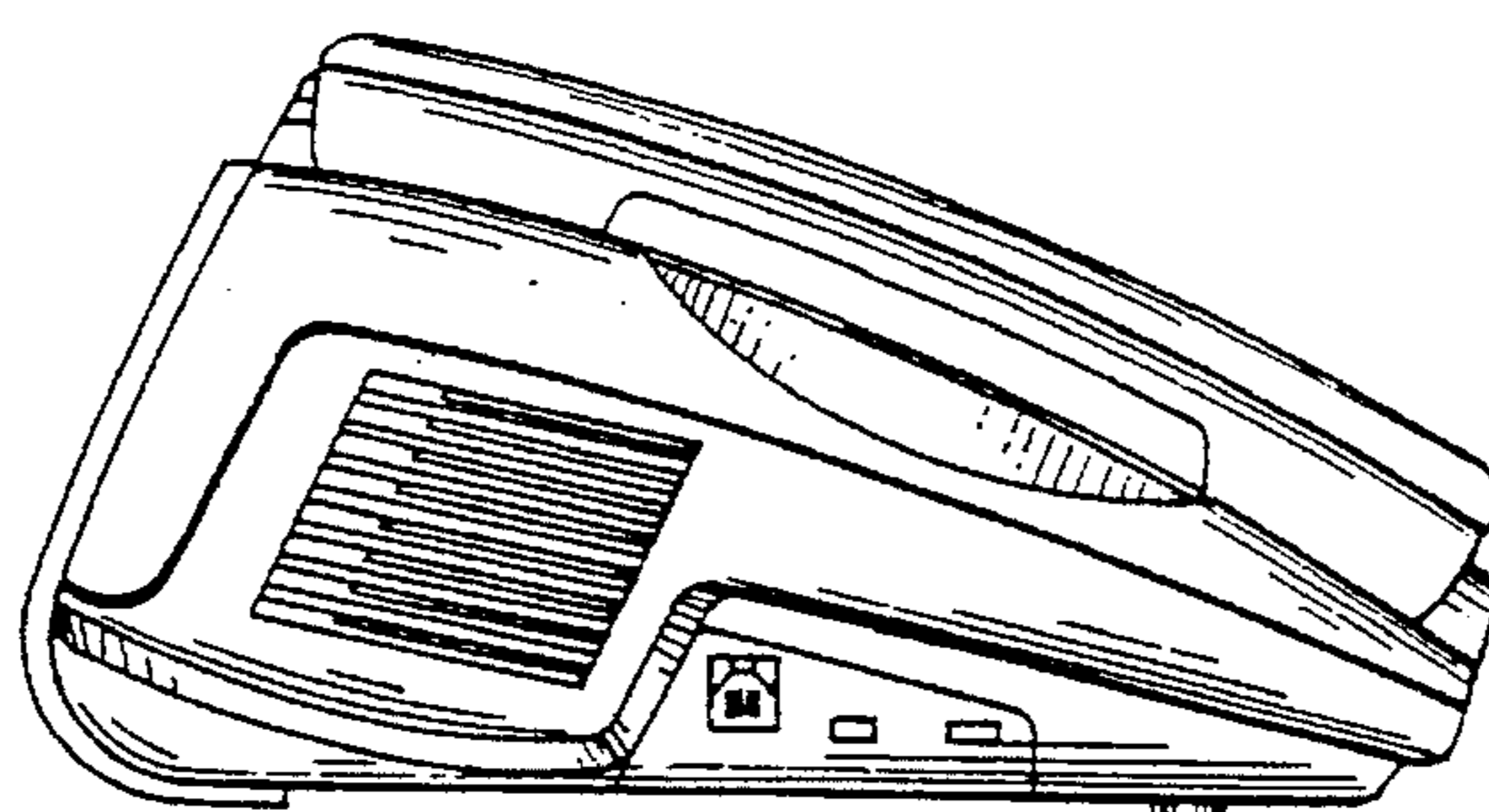
FIG, 5



FIG, 6



FIG, 7



FIG, 8

